

### **Amendments to the Specification**

*Please replace paragraph [0135] with the following amended paragraph:*

[0135] Meanwhile, the pad 32a is made of a material that does not affect the process to be carried out on the wafer W. For this reason, the pad 32a is made from a non-ferrous [metal] material. Preferably, the material of the pad may comprise a rubbery material. A silicon component may be added to the material of the pad 32a.